

## 具有三态输出的 SNx4HC126 四路缓冲器

### 1 特性

- 缓冲输入
- 宽工作电压范围：2V 至 6V
- 宽工作温度范围：  
- 40°C 至 +85°C
- 支持多达 10 个 LSTTL 负载的扇出
- 与 LSTTL 逻辑 IC 相比，可显著降低功耗

### 2 应用

- 使能数字信号

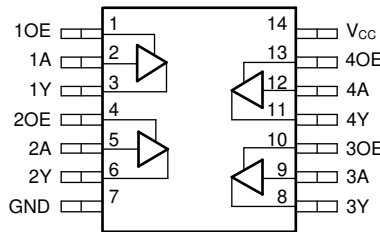
### 3 说明

此器件包含四个具有三态输出的独立缓冲器。每个逻辑门以正逻辑执行布尔函数  $Y = A$ 。

#### 器件信息<sup>(1)</sup>

| 器件型号        | 封装         | 封装尺寸 (标称值)       |
|-------------|------------|------------------|
| SN74HC126D  | SOIC (14)  | 8.70mm × 3.90mm  |
| SN74HC126DB | SSOP (14)  | 6.50mm × 5.30mm  |
| SN74HC126N  | PDIP (14)  | 19.30mm × 6.40mm |
| SN74HC126NS | SO (14)    | 10.20mm × 5.30mm |
| SN74HC126PW | TSSOP (14) | 5.00mm × 4.40mm  |
| SN54HC126J  | CDIP (14)  | 21.30mm × 7.60mm |
| SN54HC126FK | LCCC (20)  | 8.90mm × 8.90mm  |

(1) 如需了解所有可用封装，请参阅数据表末尾的可订购产品附录。



功能引脚分配

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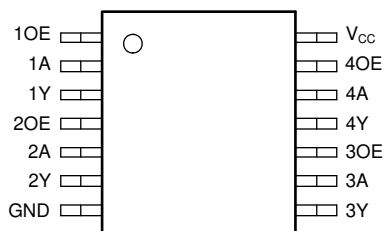
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## 4 Revision History

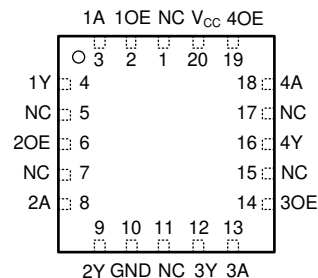
注：以前版本的页码可能与当前版本的页码不同

| <b>Changes from Revision E (July 2003) to Revision F (April 2021)</b>                                                      | <b>Page</b> |
|----------------------------------------------------------------------------------------------------------------------------|-------------|
| • 更新了整个文档的表、图和交叉参考的编号格式.....                                                                                               | <b>1</b>    |
| • 更新至全新的数据表标准.....                                                                                                         | <b>1</b>    |
| • Increased D (86 to 151.7), DB (96 to 108.0), NS (76 to 122.6), and PW (113 to 151.7); decreased N (80 to 62.5) °C/W..... | <b>4</b>    |

## 5 Pin Configuration and Functions



**图 5-1. D, DB, N, NS, PW, or J Package**  
**14-Pin SOIC, SSOP, PDIP, SO, TSSOP, or CDIP**  
**Top View**



**图 5-2. FK Package**  
**20-Pin LCCC**  
**Top View**

## Pin Functions

| NAME            | PIN                    |                     | I/O    | DESCRIPTION              |
|-----------------|------------------------|---------------------|--------|--------------------------|
|                 | D, DB, N, NS, PW, or J | FK                  |        |                          |
| 1OE             | 1                      | 2                   | Input  | Channel 1, Output Enable |
| 1A              | 2                      | 3                   | Input  | Channel 1, Input A       |
| 1Y              | 3                      | 4                   | Output | Channel 1, Output Y      |
| 2OE             | 4                      | 6                   | Input  | Channel 2, Output Enable |
| 2A              | 5                      | 8                   | Input  | Channel 2, Input A       |
| 2Y              | 6                      | 9                   | Output | Channel 2, Output Y      |
| GND             | 7                      | 10                  | —      | Ground                   |
| 3Y              | 8                      | 12                  | Output | Channel 3, Output Y      |
| 3A              | 9                      | 13                  | Input  | Channel 3, Input A       |
| 3OE             | 10                     | 14                  | Input  | Channel 3, Output Enable |
| 4Y              | 11                     | 16                  | Output | Channel 4, Output Y      |
| 4A              | 12                     | 18                  | Input  | Channel 4, Input A       |
| 4OE             | 13                     | 19                  | Input  | Channel 4, Output Enable |
| V <sub>CC</sub> | 14                     | 20                  | —      | Positive Supply          |
| NC              |                        | 1, 5, 7, 11, 15, 17 | —      | Not internally connected |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                   |                                                        | MIN   | MAX | UNIT |
|------------------|---------------------------------------------------|--------------------------------------------------------|-------|-----|------|
| V <sub>CC</sub>  | Supply voltage                                    |                                                        | – 0.5 | 7   | V    |
| I <sub>IK</sub>  | Input clamp current <sup>(2)</sup>                | V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> |       | ±20 | mA   |
| I <sub>OK</sub>  | Output clamp current <sup>(2)</sup>               | V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> |       | ±20 | mA   |
| I <sub>O</sub>   | Continuous output current                         | V <sub>O</sub> = 0 to V <sub>CC</sub>                  |       | ±35 | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND |                                                        |       | ±70 | mA   |
| T <sub>J</sub>   | Junction temperature <sup>(3)</sup>               |                                                        |       | 150 | °C   |
| T <sub>stg</sub> | Storage temperature                               |                                                        | – 65  | 150 | °C   |

(1) Stresses beyond those listed under *Absolute Maximum Rating* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Condition*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) Guaranteed by design.

### 6.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                 |                                |                         | MIN  | NOM | MAX             | UNIT |
|-----------------|--------------------------------|-------------------------|------|-----|-----------------|------|
| V <sub>CC</sub> | Supply voltage                 |                         | 2    | 5   | 6               | V    |
| V <sub>IH</sub> | High-level input voltage       | V <sub>CC</sub> = 2 V   | 1.5  |     |                 | V    |
|                 |                                | V <sub>CC</sub> = 4.5 V | 3.15 |     |                 |      |
|                 |                                | V <sub>CC</sub> = 6 V   | 4.2  |     |                 |      |
| V <sub>IL</sub> | Low-level input voltage        | V <sub>CC</sub> = 2 V   |      |     | 0.5             | V    |
|                 |                                | V <sub>CC</sub> = 4.5 V |      |     | 1.35            |      |
|                 |                                | V <sub>CC</sub> = 6 V   |      |     | 1.8             |      |
| V <sub>I</sub>  | Input voltage                  |                         | 0    |     | V <sub>CC</sub> | V    |
| V <sub>O</sub>  | Output voltage                 |                         | 0    |     | V <sub>CC</sub> | V    |
| t <sub>i</sub>  | Input transition time          | V <sub>CC</sub> = 2 V   |      |     | 1000            | ns   |
|                 |                                | V <sub>CC</sub> = 4.5 V |      |     | 500             |      |
|                 |                                | V <sub>CC</sub> = 6 V   |      |     | 400             |      |
| T <sub>A</sub>  | Operating free-air temperature | SN54HC126               | – 55 |     | 125             | °C   |
|                 |                                | SN74HC126               | – 40 |     | 85              |      |

### 6.3 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                            | SN74HC126 |           |          |         |            | UNIT |
|-------------------------------|--------------------------------------------|-----------|-----------|----------|---------|------------|------|
|                               |                                            | D (SOIC)  | DB (SSOP) | N (PDIP) | NS (SO) | PW (TSSOP) |      |
|                               |                                            | 14 PINS   | 14 PINS   | 14 PINS  | 14 PINS | 14 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance     | 133.6     | 108.0     | 62.5     | 122.6   | 151.7      | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance  | 89        | 57.8      | 50.2     | 81.8    | 79.4       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance       | 89.5      | 58.3      | 42.2     | 83.8    | 94.7       | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter | 45.5      | 18.0      | 29.8     | 45.4    | 25.2       | °C/W |

| THERMAL METRIC <sup>(1)</sup> |                                              | SN74HC126 |           |          |         |            | UNIT |
|-------------------------------|----------------------------------------------|-----------|-----------|----------|---------|------------|------|
|                               |                                              | D (SOIC)  | DB (SSOP) | N (PDIP) | NS (SO) | PW (TSSOP) |      |
|                               |                                              | 14 PINS   | 14 PINS   | 14 PINS  | 14 PINS | 14 PINS    |      |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 89.1      | 57.6      | 42.0     | 83.4    | 94.1       | °C/W |
| $R_{\theta_{JC(bot)}}$        | Junction-to-case (bottom) thermal resistance | N/A       | N/A       | N/A      | N/A     | N/A        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.4 Electrical Characteristics - 74

over operating free-air temperature range; typical values measured at  $T_A = 25^\circ\text{C}$  (unless otherwise noted).

| PARAMETER       |                             | TEST CONDITIONS                                     |                           | V <sub>CC</sub>            | Operating free-air temperature (T <sub>A</sub> ) |       |      |               |      |      | UNIT |
|-----------------|-----------------------------|-----------------------------------------------------|---------------------------|----------------------------|--------------------------------------------------|-------|------|---------------|------|------|------|
|                 |                             |                                                     |                           |                            | 25°C                                             |       |      | -40°C to 85°C |      |      |      |
|                 |                             |                                                     |                           |                            | MIN                                              | TYP   | MAX  | MIN           | TYP  | MAX  |      |
| V <sub>OH</sub> | High-level output voltage   | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = - 20 µA | 2 V                        | 1.9                                              | 1.998 |      | 1.9           |      |      | V    |
|                 |                             |                                                     |                           | 4.5 V                      | 4.4                                              | 4.499 |      | 4.4           |      |      |      |
|                 |                             |                                                     |                           | 6 V                        | 5.9                                              | 5.999 |      | 5.9           |      |      |      |
|                 |                             |                                                     | I <sub>OH</sub> = - 6 mA  | 4.5 V                      | 3.98                                             | 4.3   |      | 3.84          |      |      |      |
|                 |                             |                                                     |                           | I <sub>OH</sub> = - 7.8 mA | 6 V                                              | 5.48  | 5.8  |               | 5.34 |      |      |
| V <sub>OL</sub> | Low-level output voltage    | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OL</sub> = 20 µA   | 2 V                        |                                                  | 0.002 | 0.1  |               |      | 0.1  | V    |
|                 |                             |                                                     |                           | 4.5 V                      |                                                  | 0.001 | 0.1  |               |      | 0.1  |      |
|                 |                             |                                                     |                           | 6 V                        |                                                  | 0.001 | 0.1  |               |      | 0.1  |      |
|                 |                             |                                                     | I <sub>OL</sub> = 6 mA    | 4.5 V                      |                                                  | 0.17  | 0.26 |               |      | 0.33 |      |
|                 |                             |                                                     |                           | I <sub>OL</sub> = 7.8 mA   | 6 V                                              |       | 0.15 | 0.26          |      |      |      |
| I <sub>I</sub>  | Input leakage current       | V <sub>I</sub> = V <sub>CC</sub> or 0               |                           | 6 V                        |                                                  |       |      | ±0.1          |      | ±1   | µA   |
| I <sub>OZ</sub> | Three-state leakage current | V <sub>O</sub> = V <sub>CC</sub> or 0               |                           | 6 V                        |                                                  | ±0.01 | ±0.5 |               |      | ±5   | µA   |
| I <sub>CC</sub> | Supply current              | V <sub>I</sub> = V <sub>CC</sub> or 0               | I <sub>O</sub> = 0        | 6 V                        |                                                  |       |      | 8             |      | 80   | µA   |
| C <sub>i</sub>  | Input capacitance           |                                                     |                           | 2 V to 6 V                 |                                                  | 3     | 10   |               |      | 10   | pF   |

## 6.5 Electrical Characteristics - 54

over operating free-air temperature range; typical values measured at  $T_A = 25^\circ\text{C}$  (unless otherwise noted).

| PARAMETER       |                           | TEST CONDITIONS                                     |                           | V <sub>CC</sub> | Operating free-air temperature (T <sub>A</sub> ) |       |      |                |     |     |                 |     |     | UNIT |
|-----------------|---------------------------|-----------------------------------------------------|---------------------------|-----------------|--------------------------------------------------|-------|------|----------------|-----|-----|-----------------|-----|-----|------|
|                 |                           |                                                     |                           |                 | 25°C                                             |       |      | − 40°C to 85°C |     |     | − 55°C to 125°C |     |     |      |
|                 |                           |                                                     |                           |                 | MIN                                              | TYP   | MAX  | MIN            | TYP | MAX | MIN             | TYP | MAX |      |
| V <sub>OH</sub> | High-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = − 20 μA | 2 V             | 1.9                                              | 1.998 | 1.9  |                |     | 1.9 |                 |     | V   |      |
|                 |                           |                                                     |                           | 4.5 V           | 4.4                                              | 4.499 | 4.4  |                |     | 4.4 |                 |     |     |      |
|                 |                           |                                                     |                           | 6 V             | 5.9                                              | 5.999 | 5.9  |                |     | 5.9 |                 |     |     |      |
|                 |                           |                                                     | I <sub>OH</sub> = − 6 mA  | 4.5 V           | 3.98                                             | 4.3   | 3.84 |                |     | 3.7 |                 |     |     |      |
|                 |                           |                                                     |                           | 6 V             | 5.48                                             | 5.8   | 5.34 |                |     | 5.2 |                 |     |     |      |

over operating free-air temperature range; typical values measured at  $T_A = 25^\circ\text{C}$  (unless otherwise noted).

| PARAMETER       |                             | TEST CONDITIONS                                     |                          | V <sub>CC</sub> | Operating free-air temperature (T <sub>A</sub> ) |      |      |                |     |     |                 |     |     | UNIT |  |  |    |
|-----------------|-----------------------------|-----------------------------------------------------|--------------------------|-----------------|--------------------------------------------------|------|------|----------------|-----|-----|-----------------|-----|-----|------|--|--|----|
|                 |                             |                                                     |                          |                 | 25°C                                             |      |      | – 40°C to 85°C |     |     | – 55°C to 125°C |     |     |      |  |  |    |
|                 |                             |                                                     |                          |                 | MIN                                              | TYP  | MAX  | MIN            | TYP | MAX | MIN             | TYP | MAX |      |  |  |    |
| V <sub>OL</sub> | Low-level output voltage    | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OL</sub> = 20 μA  | 2 V             | 0.002                                            | 0.1  | 0.1  |                |     | 0.1 |                 |     | V   |      |  |  |    |
|                 |                             |                                                     |                          | 4.5 V           | 0.001                                            | 0.1  | 0.1  |                |     | 0.1 |                 |     |     |      |  |  |    |
|                 |                             |                                                     |                          | 6 V             | 0.001                                            | 0.1  | 0.1  |                |     | 0.1 |                 |     |     |      |  |  |    |
|                 |                             |                                                     | I <sub>OL</sub> = 6 mA   | 4.5 V           | 0.17                                             | 0.26 | 0.33 |                |     | 0.4 |                 |     |     |      |  |  |    |
|                 |                             |                                                     | I <sub>OL</sub> = 7.8 mA | 6 V             | 0.15                                             | 0.26 | 0.33 |                |     | 0.4 |                 |     |     |      |  |  |    |
| I <sub>I</sub>  | Input leakage current       | V <sub>I</sub> = V <sub>CC</sub> or 0               |                          | 6 V             | ±0.1                                             |      |      | ±1             |     |     | ±1              |     |     | μA   |  |  |    |
| I <sub>OZ</sub> | Three-state leakage current | V <sub>O</sub> = V <sub>CC</sub> or 0               |                          | 6 V             | ±0.01                                            |      |      | ±0.5           |     |     | ±5              |     |     | ±10  |  |  | μA |
| I <sub>CC</sub> | Supply current              | V <sub>I</sub> = V <sub>CC</sub> or 0               | I <sub>O</sub> = 0       | 6 V             | 8                                                |      |      | 80             |     |     | 160             |     |     | μA   |  |  |    |
| C <sub>i</sub>  | Input capacitance           |                                                     |                          | 2 V to 6 V      | 3                                                |      |      | 10             |     |     | 10              |     |     | pF   |  |  |    |

## 6.6 Switching Characteristics - 74

over operating free-air temperature range (unless otherwise noted)

| PARAMETER        |                   | FROM | TO | TEST CONDITIONS         | V <sub>CC</sub> | Operating free-air temperature (T <sub>A</sub> ) |     |     |                |     |     | UNIT |
|------------------|-------------------|------|----|-------------------------|-----------------|--------------------------------------------------|-----|-----|----------------|-----|-----|------|
|                  |                   |      |    |                         |                 | 25°C                                             |     |     | – 40°C to 85°C |     |     |      |
|                  |                   |      |    |                         |                 | MIN                                              | TYP | MAX | MIN            | TYP | MAX |      |
| t <sub>pd</sub>  | Propagation delay | A    | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 47                                               | 120 | 180 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 14                                               | 24  | 36  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 11                                               | 20  | 31  |                |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 67                                               | 150 | 225 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 19                                               | 30  | 45  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 15                                               | 25  | 39  |                |     |     |      |
| t <sub>en</sub>  | Enable delay      | OE   | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 57                                               | 120 | 180 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 16                                               | 24  | 36  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 12                                               | 20  | 31  |                |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 100                                              | 135 | 202 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 20                                               | 27  | 40  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 17                                               | 23  | 36  |                |     |     |      |
| t <sub>dis</sub> | Disable delay     | OE   | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 35                                               | 120 | 180 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 17                                               | 24  | 36  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 15                                               | 20  | 31  |                |     |     |      |
| t <sub>t</sub>   | Transition-time   |      | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 28                                               | 60  | 90  |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 8                                                | 12  | 18  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 6                                                | 10  | 15  |                |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 45                                               | 210 | 315 |                |     | ns  |      |
|                  |                   |      |    |                         | 4.5 V           | 17                                               | 42  | 63  |                |     |     |      |
|                  |                   |      |    |                         | 6 V             | 13                                               | 36  | 53  |                |     |     |      |

## 6.7 Switching Characteristics - 54

over operating free-air temperature range; typical values measured at  $T_A = 25^\circ\text{C}$  (unless otherwise noted).

| PARAMETER        |                   | FROM | TO | TEST CONDITIONS         | V <sub>CC</sub> | Operating free-air temperature (T <sub>A</sub> ) |     |     |                |     |     |                 |     |     | UNIT |
|------------------|-------------------|------|----|-------------------------|-----------------|--------------------------------------------------|-----|-----|----------------|-----|-----|-----------------|-----|-----|------|
|                  |                   |      |    |                         |                 | 25°C                                             |     |     | – 40°C to 85°C |     |     | – 55°C to 125°C |     |     |      |
|                  |                   |      |    |                         |                 | MIN                                              | TYP | MAX | MIN            | TYP | MAX | MIN             | TYP | MAX |      |
| t <sub>pd</sub>  | Propagation delay | A    | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 47                                               | 120 |     |                | 180 |     | 150             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 14                                               | 24  |     |                | 36  |     | 30              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 11                                               | 20  |     |                | 31  |     | 26              |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 67                                               | 150 |     |                | 225 |     | 188             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 19                                               | 30  |     |                | 45  |     | 38              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 15                                               | 25  |     |                | 39  |     | 33              |     |     |      |
| t <sub>en</sub>  | Enable delay      | OE   | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 57                                               | 120 |     |                | 180 |     | 150             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 16                                               | 24  |     |                | 36  |     | 30              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 12                                               | 20  |     |                | 31  |     | 26              |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 100                                              | 135 |     |                | 202 |     | 169             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 20                                               | 27  |     |                | 40  |     | 36              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 17                                               | 23  |     |                | 36  |     | 30              |     |     |      |
| t <sub>dis</sub> | Disable delay     | OE   | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 35                                               | 120 |     |                | 180 |     | 150             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 17                                               | 24  |     |                | 36  |     | 30              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 15                                               | 20  |     |                | 31  |     | 26              |     |     |      |
| t <sub>t</sub>   | Transition-time   |      | Y  | C <sub>L</sub> = 50 pF  | 2 V             | 28                                               | 60  |     |                | 90  |     | 75              | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 8                                                | 12  |     |                | 18  |     | 15              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 6                                                | 10  |     |                | 15  |     | 13              |     |     |      |
|                  |                   |      |    | C <sub>L</sub> = 150 pF | 2 V             | 45                                               | 210 |     |                | 315 |     | 265             | ns  |     |      |
|                  |                   |      |    |                         | 4.5 V           | 17                                               | 42  |     |                | 63  |     | 53              |     |     |      |
|                  |                   |      |    |                         | 6 V             | 13                                               | 36  |     |                | 53  |     | 45              |     |     |      |

## 6.8 Operating Characteristics

over operating free-air temperature range; typical values measured at  $T_A = 25^\circ\text{C}$  (unless otherwise noted).

| PARAMETER |                                        | TEST CONDITIONS | $V_{CC}$   | MIN | TYP | MAX | UNIT |
|-----------|----------------------------------------|-----------------|------------|-----|-----|-----|------|
| $C_{pd}$  | Power dissipation capacitance per gate | No load         | 2 V to 6 V |     | 45  |     | pF   |

## 6.9 Typical Characteristics

$T_A = 25^\circ\text{C}$

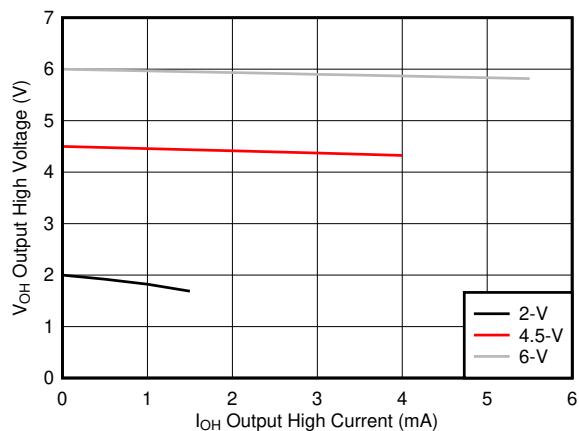


图 6-1. Typical output voltage in the high state ( $V_{OH}$ )

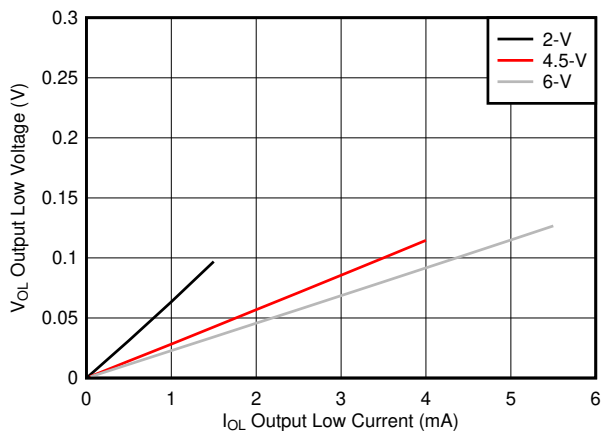
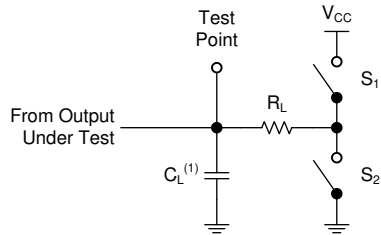


图 6-2. Typical output voltage in the low state ( $V_{OL}$ )



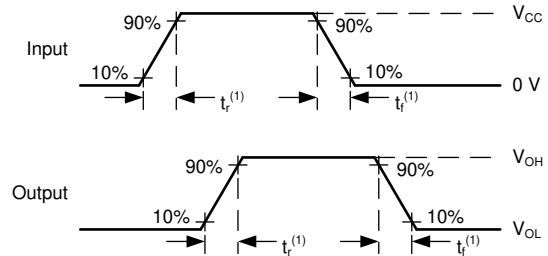
## 7 Parameter Measurement Information

- Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_t < 6 \text{ ns}$ .
- The outputs are measured one at a time, with one input transition per measurement.



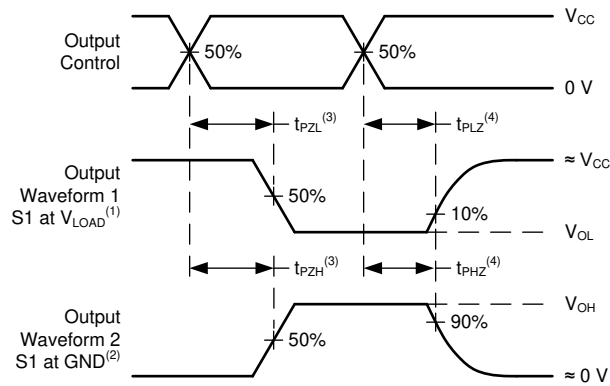
A.  $C_L = 50 \text{ pF}$  and includes probe and jig capacitance.

**图 7-1. Load Circuit**



A.  $t_t$  is the greater of  $t_r$  and  $t_f$ .

**图 7-2. Voltage Waveforms Transition Times**



A. The maximum between  $t_{PLH}$  and  $t_{PHL}$  is used for  $t_{pd}$ .

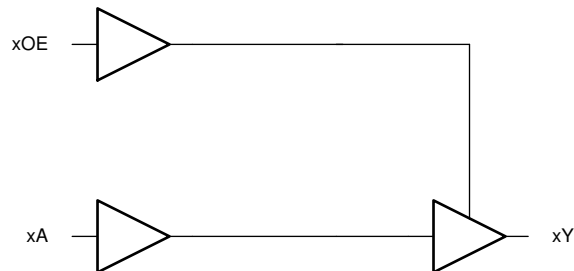
**图 7-3. Voltage Waveforms Propagation Delays**

## 8 Detailed Description

### 8.1 Overview

This device contains four independent buffers with 3-state outputs. Each gate performs the Boolean function  $Y = A$  in positive logic.

### 8.2 Functional Block Diagram



### 8.3 Feature Description

#### 8.3.1 Balanced CMOS 3-State Outputs

A balanced output allows the device to sink and source similar currents. The drive capability of this device may create fast edges into light loads so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important for the output power of the device to be limited to avoid damage due to over-current. The electrical and thermal limits defined in the [Absolute Maximum Ratings](#) must be followed at all times.

The SN74HC126 can drive a load with a total capacitance less than or equal to the maximum load listed in the [Switching Characteristics - 74](#) connected to a high-impedance CMOS input while still meeting all of the datasheet specifications. Larger capacitive loads can be applied, however it is not recommended to exceed the provided load value. If larger capacitive loads are required, it is recommended to add a series resistor between the output and the capacitor to limit output current to the values given in the [Absolute Maximum Ratings](#).

3-State outputs can be placed into a high-impedance state. In this state, the output will neither source nor sink current, and leakage current is defined by the  $I_{OZ}$  specification in the [Electrical Characteristics - 74](#). A pull-up or pull-down resistor can be used to ensure that the output remains HIGH or LOW, respectively, during the high-impedance state.

#### 8.3.2 Standard CMOS Inputs

Standard CMOS inputs are high impedance and are typically modeled as a resistor from the input to ground in parallel with the input capacitance given in the [Electrical Characteristics - 74](#). The worst case resistance is calculated with the maximum input voltage, given in the [Absolute Maximum Ratings](#), and the maximum input leakage current, given in the [Electrical Characteristics - 74](#), using ohm's law ( $R = V \div I$ ).

Signals applied to the inputs need to have fast edge rates, as defined by the input transition time in the [Recommended Operating Conditions](#) to avoid excessive current consumption and oscillations. If a slow or noisy input signal is required, a device with a Schmitt-trigger input should be used to condition the input signal prior to the standard CMOS input.

### 8.3.3 Clamp Diode Structure

The inputs and outputs to this device have both positive and negative clamping diodes as depicted in 图 8-1.

#### CAUTION

Voltages beyond the values specified in the 表 6.1 table can cause damage to the device. The recommended input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

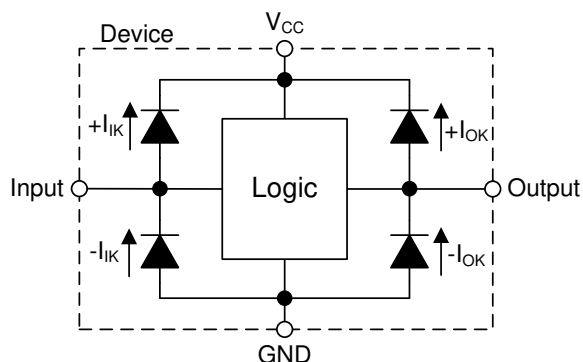


图 8-1. Electrical Placement of Clamping Diodes for Each Input and Output

### 8.4 Device Functional Modes

表 8-1. Function Table

| INPUTS |   | OUTPUT |
|--------|---|--------|
| OE     | A | Y      |
| L      | X | Z      |
| H      | L | L      |
| H      | H | H      |

## 9 Application and Implementation

### 备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

### 9.1 Application Information

In this application, a 3-state buffer is used to enable or disable a data connection as shown in [图 9-1](#). It is common to see all four channels of a device used together for controlling a 4-bit data bus, however each channel of the device can be used independently. Unused channels should have the inputs terminated at ground or  $V_{CC}$  and the output left unconnected.

When the output of the device is active, the data signal will be replicated at the output. When the output of the device is disabled, the output will be in a high-impedance state, and the output voltage will be determined by the circuit connected to the output pin. This circuit is most commonly used when a bus must be completely disabled. One example of this situation is when the circuitry connected to the output is to be powered off for an extended period of time to save system power, and the inputs to that circuitry cannot have a voltage present due to protective clamp diodes.

### 9.2 Typical Application

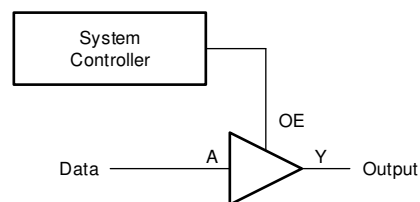


图 9-1. Typical application schematic

#### 9.2.1 Design Requirements

##### 9.2.1.1 Power Considerations

Ensure the desired supply voltage is within the range specified in the [Recommended Operating Conditions](#). The supply voltage sets the device's electrical characteristics as described in the [Electrical Characteristics - 74](#).

The supply must be capable of sourcing current equal to the total current to be sourced by all outputs of the SN74HC126 plus the maximum supply current,  $I_{CC}$ , listed in the [Electrical Characteristics - 74](#). The logic device can only source or sink as much current as it is provided at the supply and ground pins, respectively. Be sure not to exceed the maximum total current through GND or  $V_{CC}$  listed in the [Absolute Maximum Ratings](#).

Total power consumption can be calculated using the information provided in [CMOS Power Consumption and  \$C\_{pd}\$  Calculation](#).

Thermal increase can be calculated using the information provided in [Thermal Characteristics of Standard Linear and Logic \(SLL\) Packages and Devices](#).

#### CAUTION

The maximum junction temperature,  $T_J(\text{max})$  listed in the [Absolute Maximum Ratings](#), is an *additional limitation* to prevent damage to the device. Do not violate any values listed in the [Absolute Maximum Ratings](#). These limits are provided to prevent damage to the device.

##### 9.2.1.2 Input Considerations

Unused inputs must be terminated to either  $V_{CC}$  or ground. These can be directly terminated if the input is completely unused, or they can be connected with a pull-up or pull-down resistor if the input is to be used.

sometimes, but not always. A pull-up resistor is used for a default state of HIGH, and a pull-down resistor is used for a default state of LOW. The resistor size is limited by drive current of the controller, leakage current into the SN74HC126, as specified in the [Electrical Characteristics - 74](#), and the desired input transition rate. A 10-k $\Omega$  resistor value is often used due to these factors.

The SN74HC126 has standard CMOS inputs, so input signal edge rates cannot be slow. Slow input edge rates can cause oscillations and damaging shoot-through current. The recommended rates are defined in the [Recommended Operating Conditions](#).

Refer to [§ 8.3](#) for additional information regarding the inputs for this device.

### 9.2.1.3 Output Considerations

The positive supply voltage is used to produce the output HIGH voltage. Drawing current from the output will decrease the output voltage as specified by the  $V_{OH}$  specification in the [Electrical Characteristics - 74](#). Similarly, the ground voltage is used to produce the output LOW voltage. Sinking current into the output will increase the output voltage as specified by the  $V_{OL}$  specification in the [Electrical Characteristics - 74](#).

Unused outputs can be left floating. Do not connect outputs directly to  $V_{CC}$  or ground.

Refer to [§ 8.3](#) for additional information regarding the outputs for this device.

## 9.2.2 Detailed Design Procedure

1. Add a decoupling capacitor from  $V_{CC}$  to GND. The capacitor needs to be placed physically close to the device and electrically close to both the  $V_{CC}$  and GND pins. An example layout is shown in [§ 11](#).
2. Ensure the capacitive load at the output is  $\leq 70$  pF. This is not a hard limit, however it will ensure optimal performance. This can be accomplished by providing short, appropriately sized traces from the SN74HC126 to the receiving device.
3. Ensure the resistive load at the output is larger than  $(V_{CC} / I_{O(max)}) \Omega$ . This will ensure that the maximum output current from the [Absolute Maximum Ratings](#) is not violated. Most CMOS inputs have a resistive load measured in megaohms; much larger than the minimum calculated above.
4. Thermal issues are rarely a concern for logic gates, however the power consumption and thermal increase can be calculated using the steps provided in the application report, [CMOS Power Consumption and Cpd Calculation](#)

### 9.2.3 Application Curves

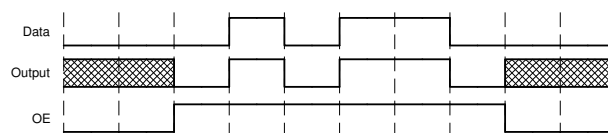


图 9-2. Typical application timing diagram

## 10 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the [节 6.2](#). Each  $V_{CC}$  terminal should have a bypass capacitor to prevent power disturbance. A 0.1- $\mu$ F capacitor is recommended for this device. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. The 0.1- $\mu$ F and 1- $\mu$ F capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results, as shown in [图 11-1](#).

## 11 Layout

### 11.1 Layout Guidelines

When using multiple-input and multiple-channel logic devices inputs must not ever be left floating. In many cases, functions or parts of functions of digital logic devices are unused; for example, when only two inputs of a triple-input AND gate are used. Such unused input pins must not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. All unused inputs of digital logic devices must be connected to a logic high or logic low voltage, as defined by the input voltage specifications, to prevent them from floating. The logic level that must be applied to any particular unused input depends on the function of the device. Generally, the inputs are tied to GND or  $V_{CC}$ , whichever makes more sense for the logic function or is more convenient.

### 11.2 Layout Example

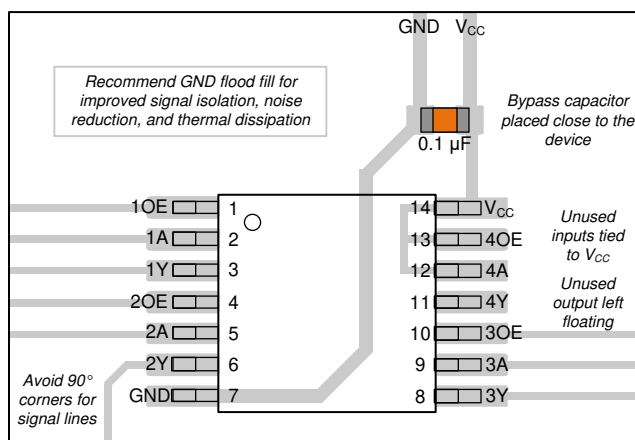


图 11-1. Example layout for the SN74HC126

## 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

For related documentation see the following:

- [HCMOS Design Considerations](#)
- [CMOS Power Consumption and CPD Calculation](#)
- [Designing with Logic](#)

#### 12.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

### 12.3 支持资源

[TI E2E™ 支持论坛](#)是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

### 12.4 Trademarks

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### 12.5 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 12.6 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

## 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|---------------------|--------------------------------------|----------------------|--------------|----------------------------------------|-------------------------|
| 5962-86848012A   | ACTIVE        | LCCC         | FK              | 20   | 1           | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>86848012A<br>SNJ54HC<br>126FK | <a href="#">Samples</a> |
| 5962-8684801CA   | ACTIVE        | CDIP         | J               | 14   | 1           | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-8684801CA<br>SNJ54HC126J          | <a href="#">Samples</a> |
| SN54HC126J       | ACTIVE        | CDIP         | J               | 14   | 1           | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | SN54HC126J                             | <a href="#">Samples</a> |
| SN74HC126D       | ACTIVE        | SOIC         | D               | 14   | 50          | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126DBR     | ACTIVE        | SSOP         | DB              | 14   | 2000        | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126DR      | ACTIVE        | SOIC         | D               | 14   | 2500        | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126DT      | ACTIVE        | SOIC         | D               | 14   | 250         | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126N       | ACTIVE        | PDIP         | N               | 14   | 25          | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -40 to 85    | SN74HC126N                             | <a href="#">Samples</a> |
| SN74HC126NSR     | ACTIVE        | SO           | NS              | 14   | 2000        | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126PW      | ACTIVE        | TSSOP        | PW              | 14   | 90          | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126PWR     | ACTIVE        | TSSOP        | PW              | 14   | 2000        | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SN74HC126PWT     | ACTIVE        | TSSOP        | PW              | 14   | 250         | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | HC126                                  | <a href="#">Samples</a> |
| SNJ54HC126FK     | ACTIVE        | LCCC         | FK              | 20   | 1           | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-<br>86848012A<br>SNJ54HC<br>126FK | <a href="#">Samples</a> |
| SNJ54HC126J      | ACTIVE        | CDIP         | J               | 14   | 1           | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-8684801CA<br>SNJ54HC126J          | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.



**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54HC126, SN74HC126 :**

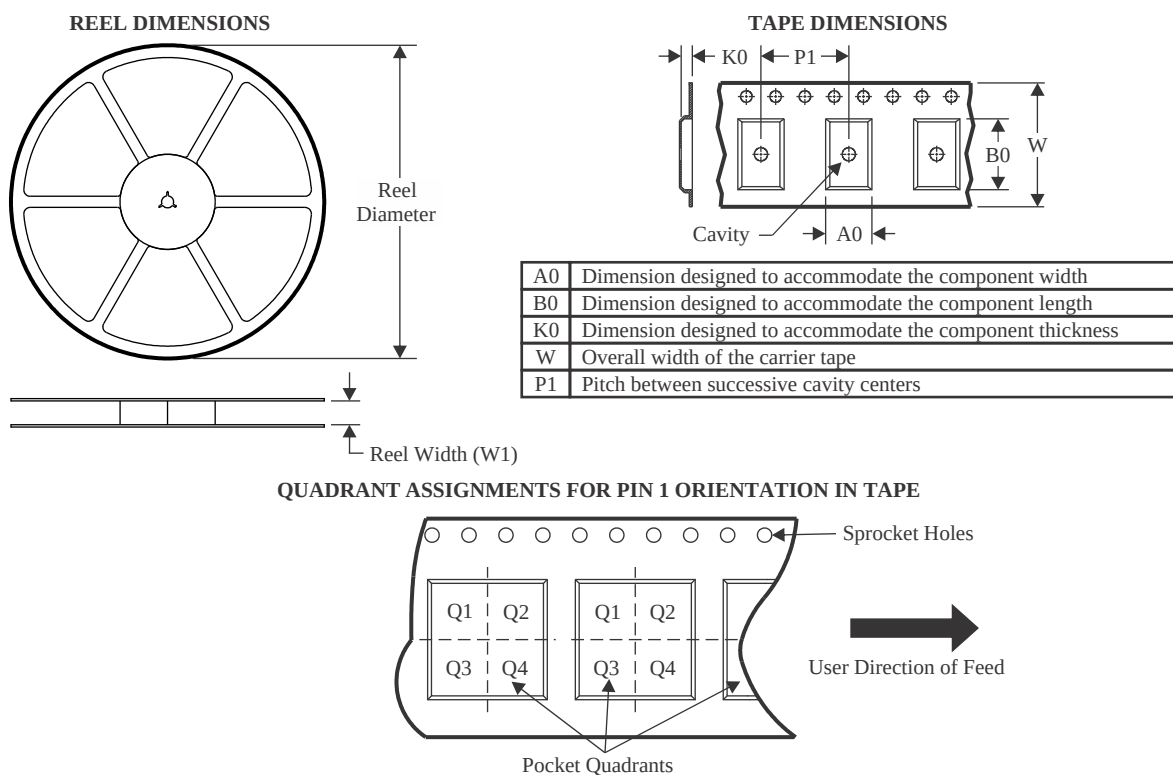
● Catalog : [SN74HC126](#)

● Military : [SN54HC126](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

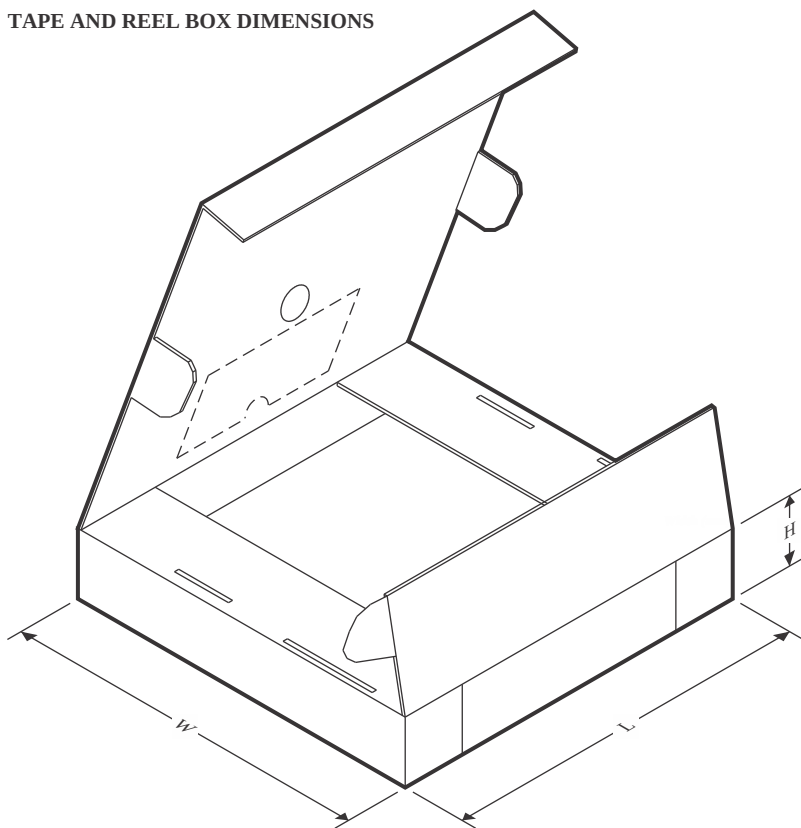
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74HC126DBR | SSOP         | DB              | 14   | 2000 | 330.0              | 16.4               | 8.35    | 6.6     | 2.4     | 12.0    | 16.0   | Q1            |
| SN74HC126DR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.6     | 9.3     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74HC126DR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74HC126DT  | SOIC         | D               | 14   | 250  | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74HC126NSR | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.45    | 10.55   | 2.5     | 12.0    | 16.2   | Q1            |
| SN74HC126PWR | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.85    | 5.45    | 1.6     | 8.0     | 12.0   | Q1            |
| SN74HC126PWR | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| SN74HC126PWT | TSSOP        | PW              | 14   | 250  | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

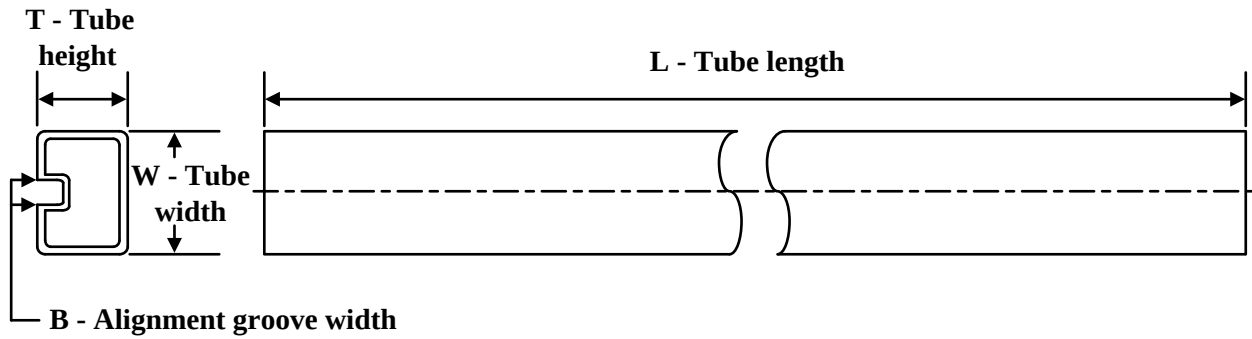
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HC126DBR | SSOP         | DB              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC126DR  | SOIC         | D               | 14   | 2500 | 366.0       | 364.0      | 50.0        |
| SN74HC126DR  | SOIC         | D               | 14   | 2500 | 367.0       | 367.0      | 38.0        |
| SN74HC126DT  | SOIC         | D               | 14   | 250  | 210.0       | 185.0      | 35.0        |
| SN74HC126NSR | SO           | NS              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC126PWR | TSSOP        | PW              | 14   | 2000 | 366.0       | 364.0      | 50.0        |
| SN74HC126PWR | TSSOP        | PW              | 14   | 2000 | 356.0       | 356.0      | 35.0        |
| SN74HC126PWT | TSSOP        | PW              | 14   | 250  | 356.0       | 356.0      | 35.0        |

## TUBE



\*All dimensions are nominal

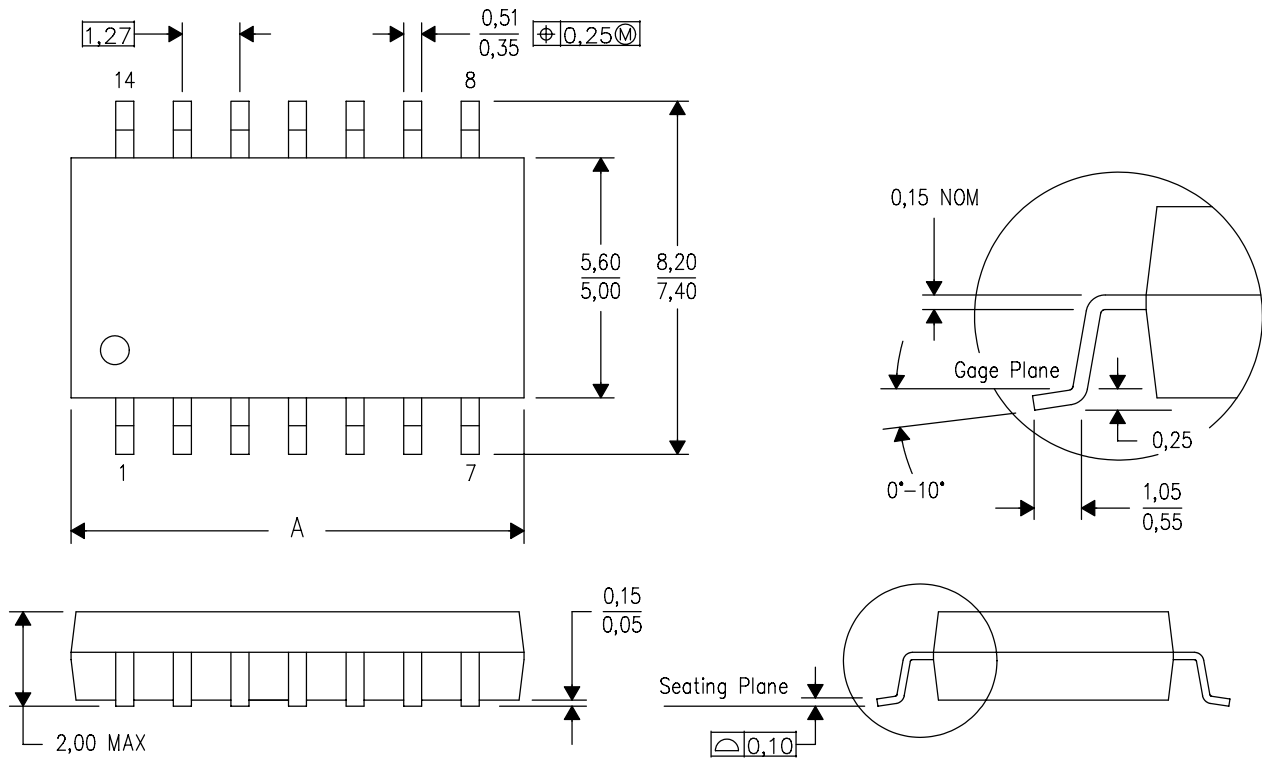
| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-86848012A | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |
| SN74HC126D     | D            | SOIC         | 14   | 50  | 506.6  | 8      | 3940   | 4.32   |
| SN74HC126N     | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC126N     | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC126PW    | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |
| SNJ54HC126FK   | FK           | LCCC         | 20   | 1   | 506.98 | 12.06  | 2030   | NA     |

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

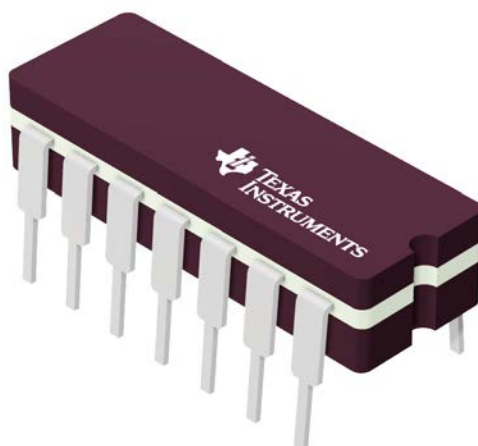
- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

**J 14**

## GENERIC PACKAGE VIEW

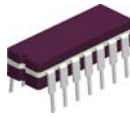
**CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE

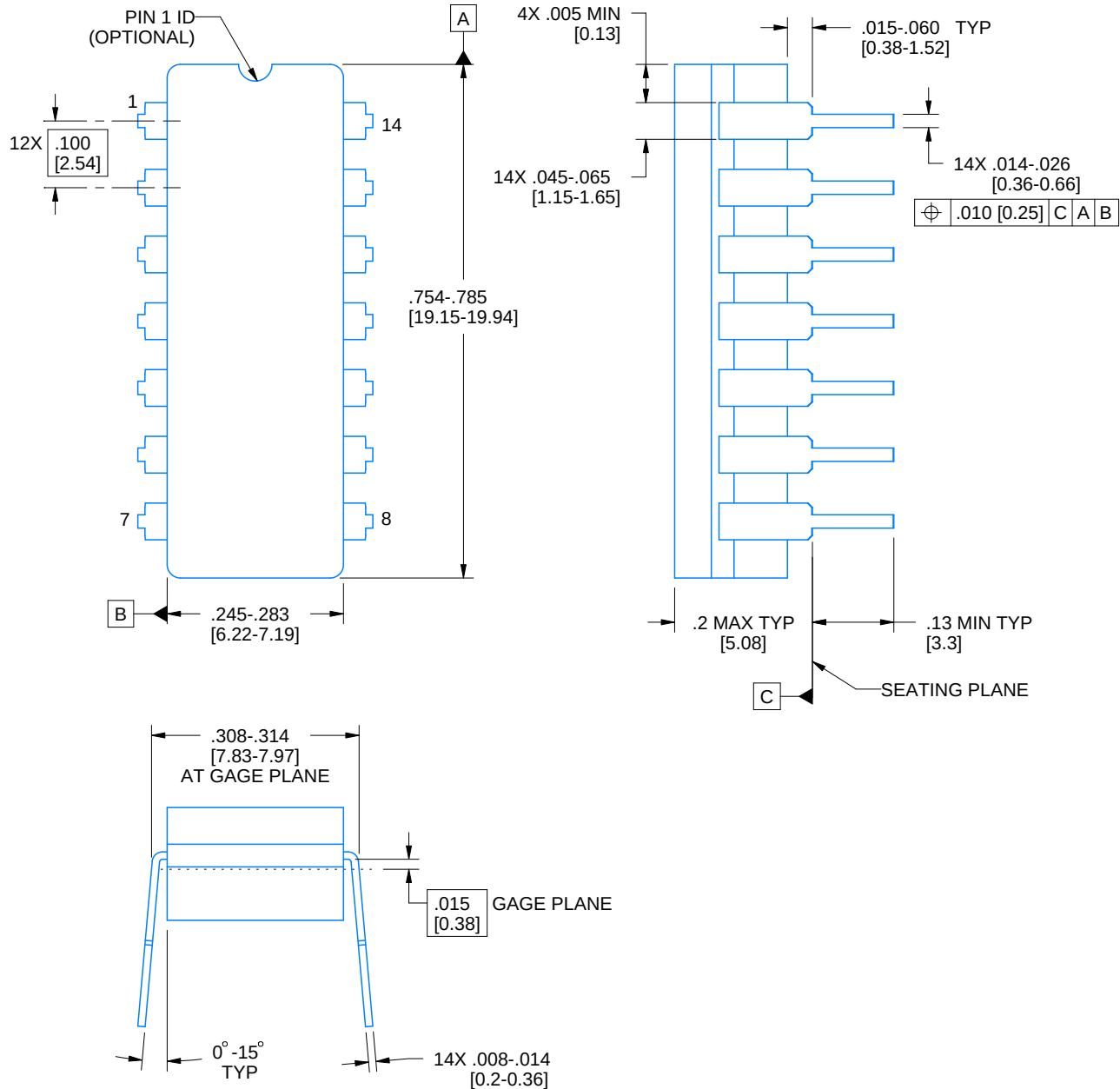


Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4040083-5/G

**J0014A****PACKAGE OUTLINE****CDIP - 5.08 mm max height**

CERAMIC DUAL IN LINE PACKAGE



4214771/A 05/2017

**NOTES:**

1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This package is hermetically sealed with a ceramic lid using glass frit.
4. Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
5. Falls within MIL-STD-1835 and GDIP1-T14.



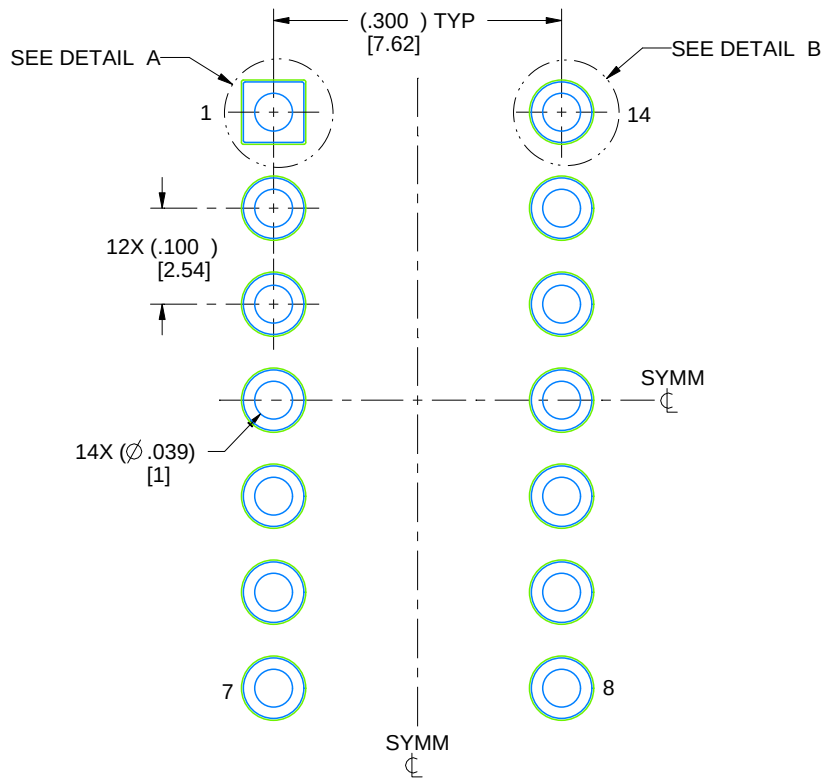
**TEXAS  
INSTRUMENTS**  
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# EXAMPLE BOARD LAYOUT

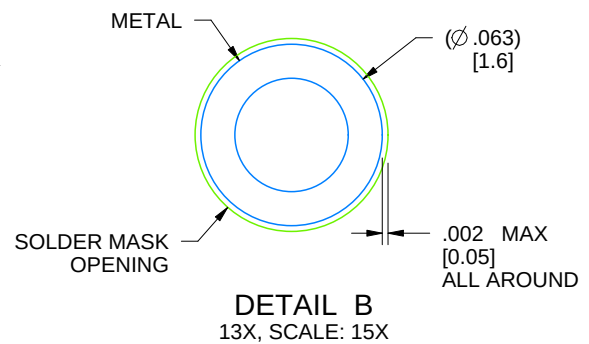
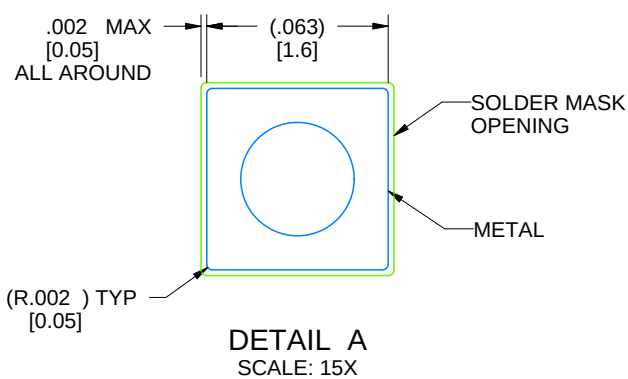
J0014A

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 5X

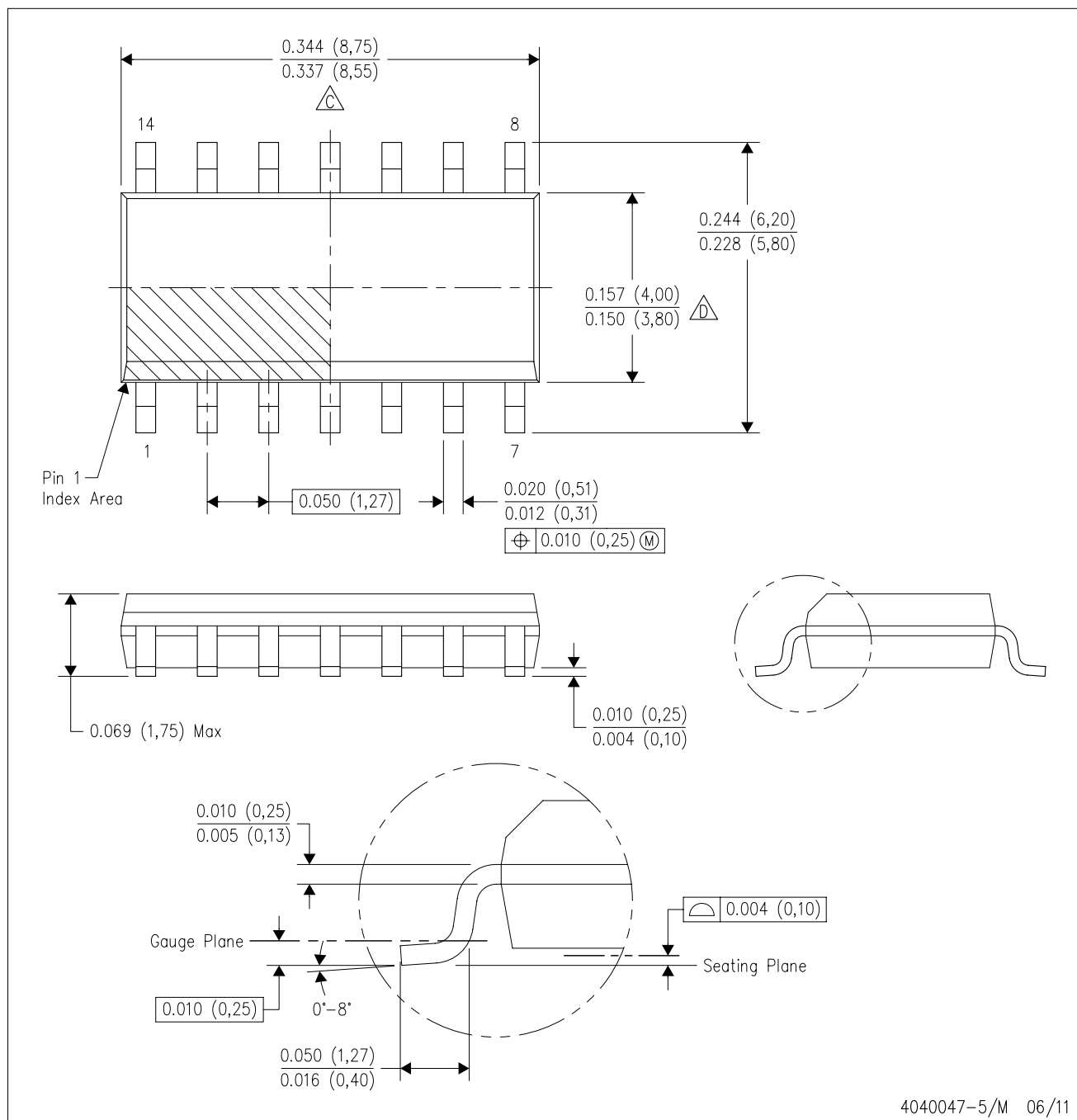


4214771/A 05/2017



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

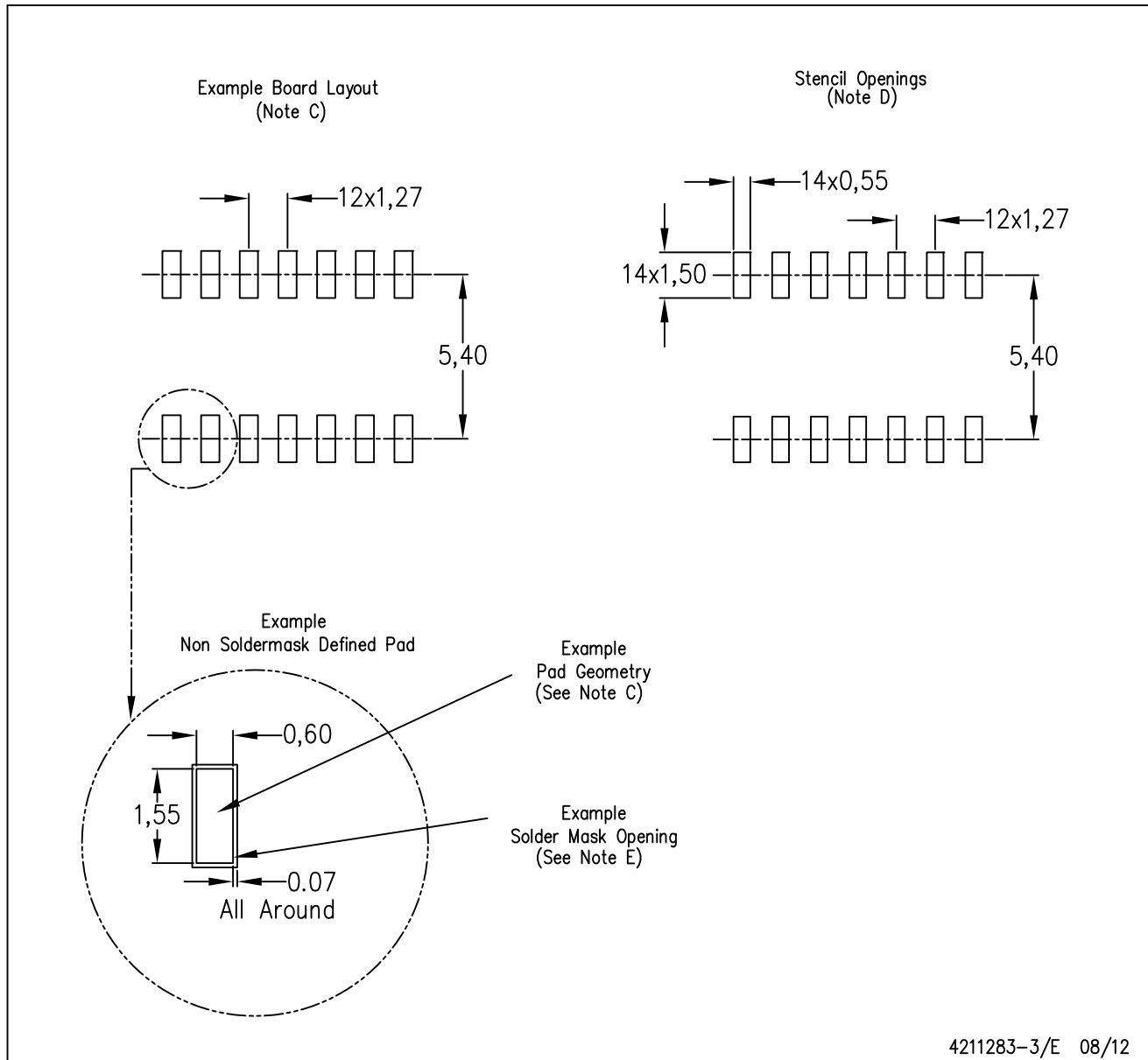


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

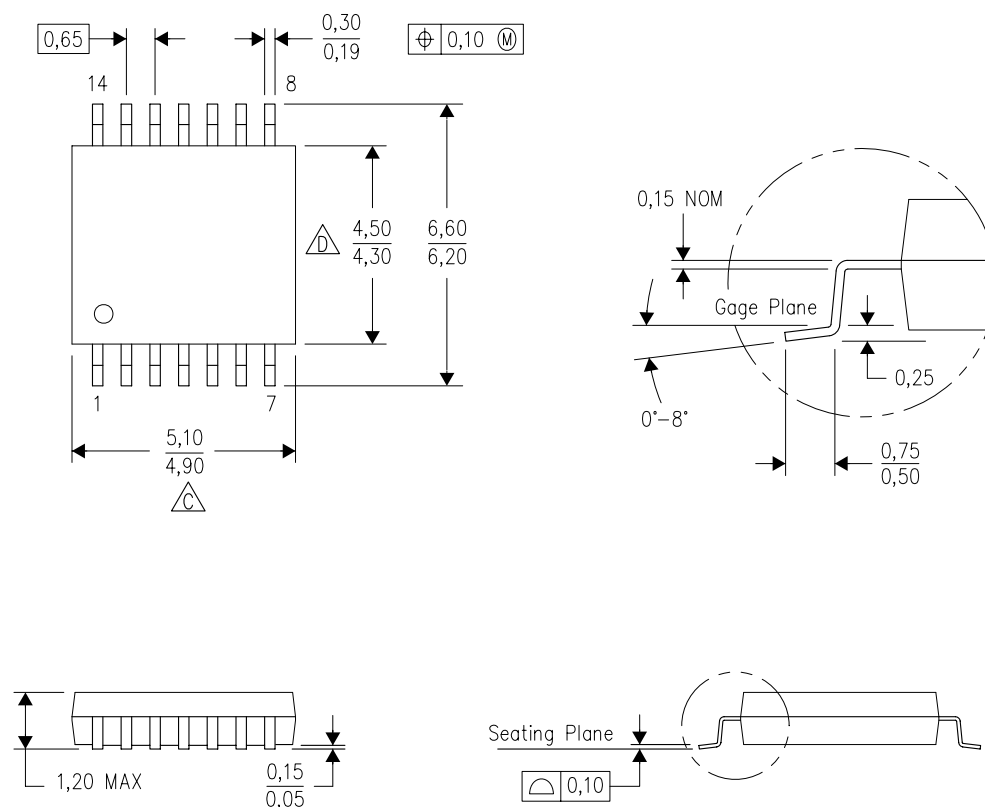


- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## MECHANICAL DATA

PW (R-PDSO-G14)

## PLASTIC SMALL OUTLINE



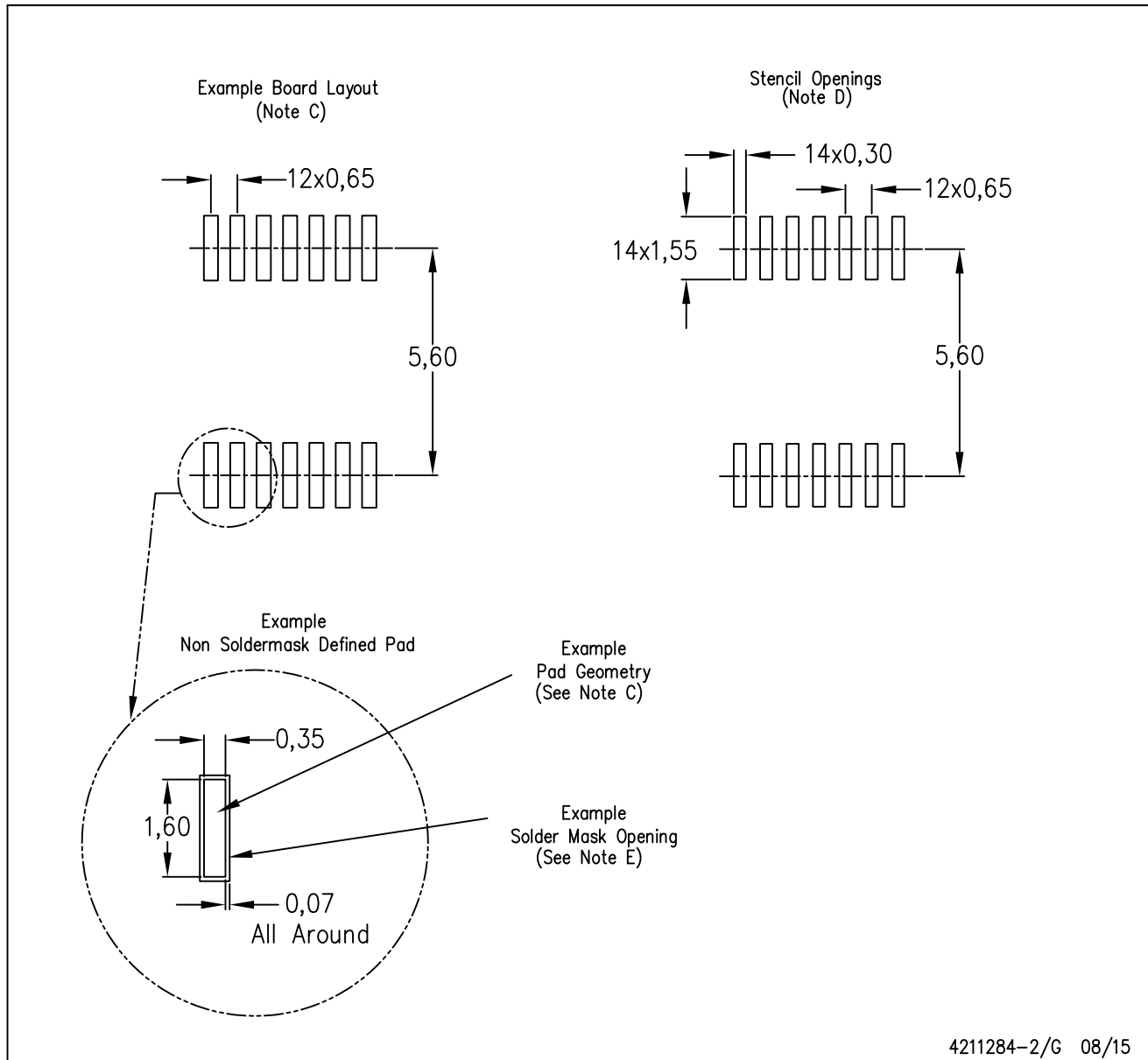
4040064-3/G 02/11

NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
-  C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
-  D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
- E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

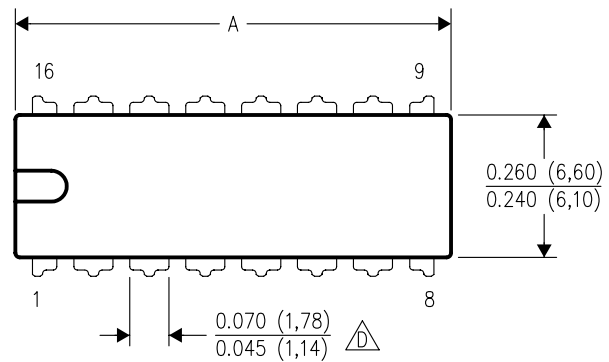


- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

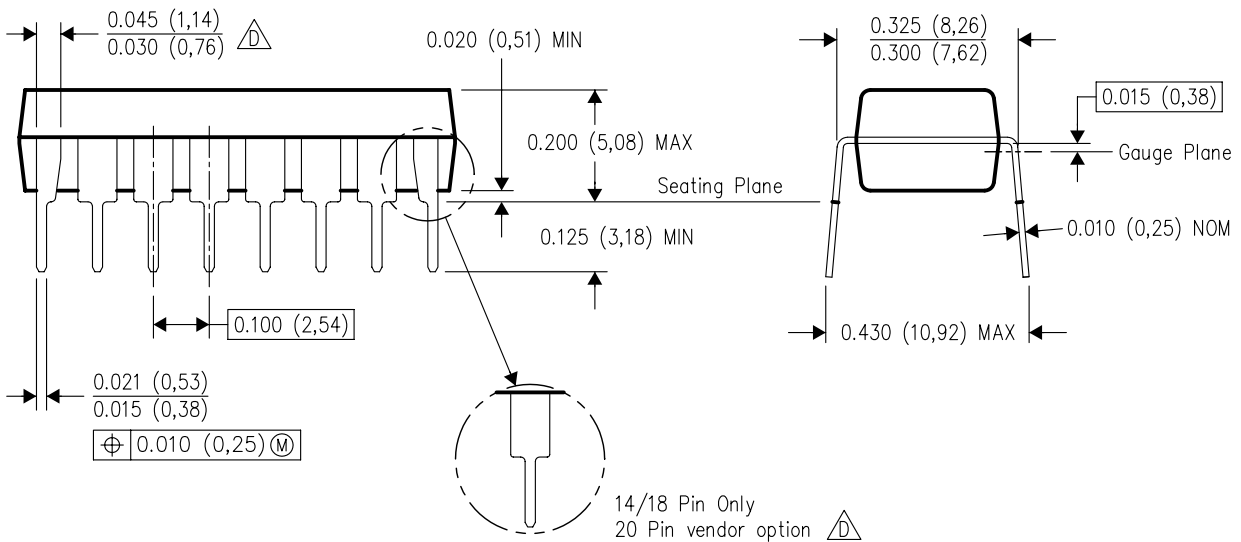
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

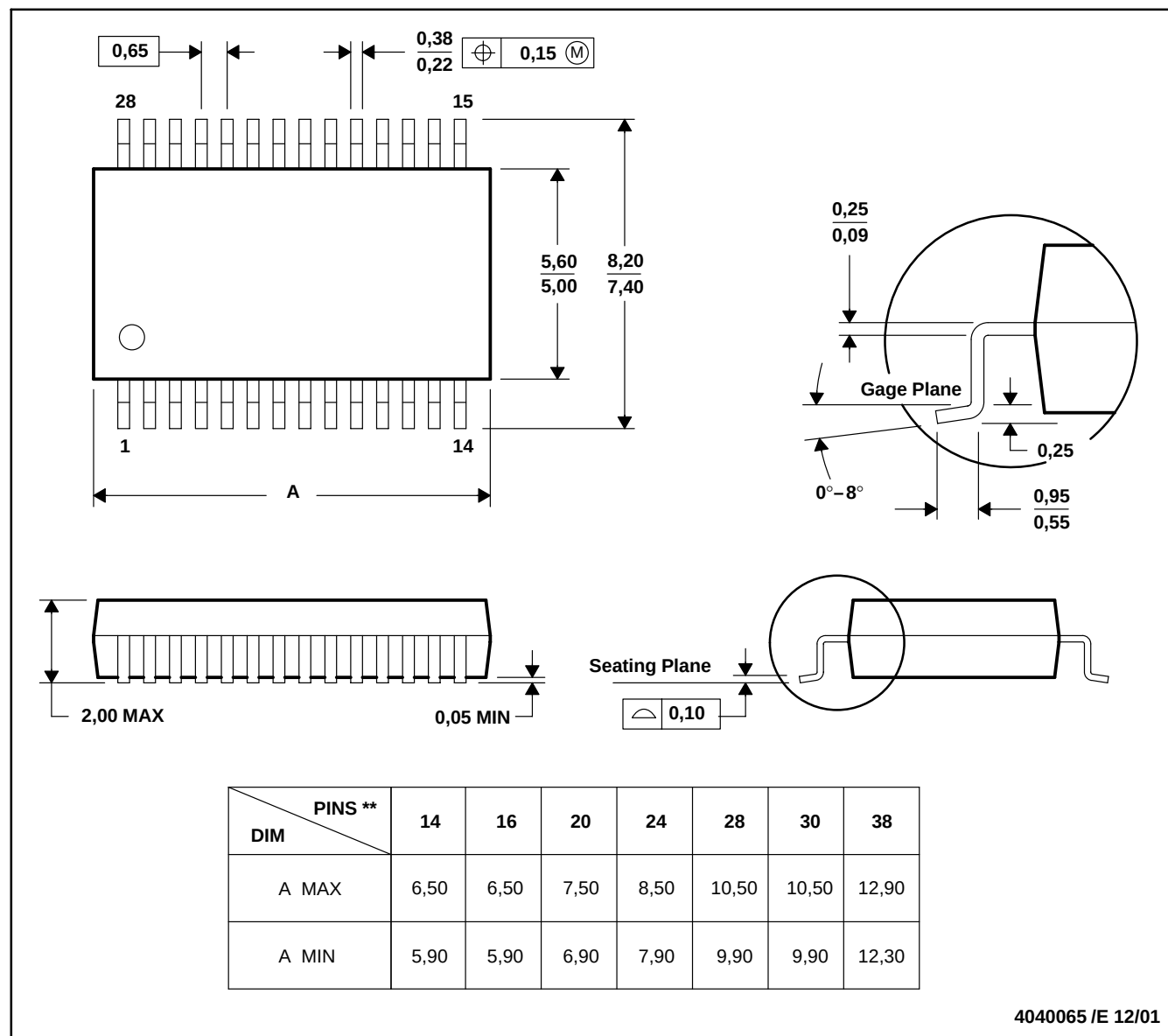
4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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